



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(on) max}	I _D T _A = +25°C
Q2	40V	24mΩ @ V _{GS} = 10V	6.9A
QZ	400	$32m\Omega$ @ $V_{GS} = 4.5V$	6.0A
Q1	-40V	45mΩ @ V _{GS} = -10V	-5.1A
Q I	- 4 0 V	55 m Ω @ V _{GS} = -4.5V	-4.5A

Description

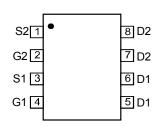
This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- · Power Management Functions
- Backlighting



Top View



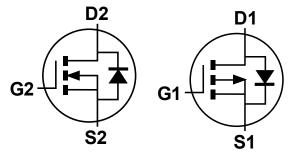
TOP VIEW Internal Schematic

Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (approximate)



N-Channel MOSFET P-Channel MOSFET

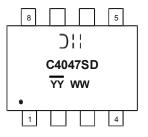
Ordering Information (Note 4)

The state of the s		
Part Number	Case	Packaging
DMC4047LSD-13	SO-8	2.500/Tape & Reel

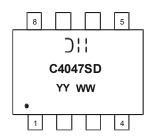
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Chengdu A/T Site



Shanghai A/T Site

Oll = Manufacturer's Marking C4047SD = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 13 = 2013)

WW = Week (01 - 53)

YY = Date Code Marking for SAT (Shanghai Assembly/ Test site)
YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value_Q2	Value_Q1	Units		
Drain-Source Voltage	V_{DSS}	40	-40	V		
Gate-Source Voltage	V _{GSS}	±20	±20	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	7.0 5.6	-5.1 -4.1	Α
Continuous Diam Current (Note 6) VGS - 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	9.0 7.2	-6.5 -5.2	Α
Maximum Body Diode Forward Current (Note 6)	I _S	2.5	-2.5	Α		
Pulsed Drain Current (10µs pulse, duty cycle = 19	I _{DM}	70	-40	Α		
Avalanche Current (Notes 7) L = 0.1mH	I _{AR}	20	20	А		
Repetitive Avalanche Energy (Notes 7) L = 0.1m	E _{AR}	20	20	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)	T _A = +25°C	Б	1.3	W
Total Fower Dissipation (Note 5)	T _A = +70°C	P_{D}	0.8	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	0	98	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ hetaJA}$	59	
Total Power Dissipation (Note 6)	T _A = +25°C	D	1.8	W
Total Fower Dissipation (Note 6)	T _A = +70°C	P_{D}	1.1	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	C	71	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	43	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	11.8	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics N-Channel Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V$, $I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 40V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS} = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	1.4	_	2.4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	D	_	15	24	mΩ	V _{GS} = 10V, I _D = 6A
Static Dialii-Source Off-Resistance	R _{DS(ON)}	_	20	32	11122	$V_{GS} = 4.5V, I_D = 5A$
Diode Forward Voltage	V_{SD}	_	0.7	1.0	V	$V_{GS} = 0V, I_S = 1.0A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	1060	_		\\ - 20\\ \\ - 0\\
Output Capacitance	Coss	_	84	_	pF	$V_{DS} = 20V$, $V_{GS} = 0V$, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	58	_		
Gate Resistance	R_G	_	1.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	8.8	_		
Total Gate Charge (V _{GS} = 10V)	Q_g	_	19.1	_	nC	V _{DS} = 20V. I _D = 8A
Gate-Source Charge	Q_{gs}	_	3.0	_	110	V _{DS} - 20V, I _D - 8A
Gate-Drain Charge	Q_{gd}	_	2.5	_		
Turn-On Delay Time	t _{D(on)}	_	5.3	_		$V_{DD} = 25V, R_L = 2.5\Omega$
Turn-On Rise Time	t _r	_	7.1	_	nS	
Turn-Off Delay Time	t _{D(off)}	_	15.1	_	113	V_{GS} = 10V, R_G = 3 Ω
Turn-Off Fall Time	t _f	_	4.8	_		
Body Diode Reverse Recovery Time	t _{rr}	_	10.5	_	nS	I _F = 8A, di/dt = 100A/μs
Body Diode Reverse Recovery Charge	Q _{rr}	_	4.15	_	nC	$I_F = 8A$, di/dt = 100A/ μ s



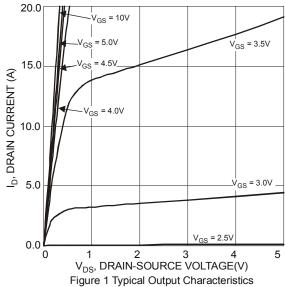
Electrical Characteristics P-Channel Q1 (@T_A = +25°C, unless otherwise specified.)

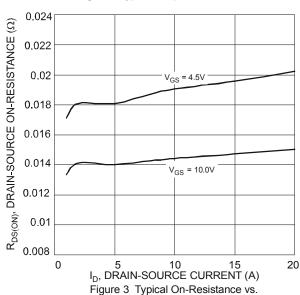
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-40		_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}			-1	μΑ	V _{DS} = -40V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	-1.0		-2.2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Desir Course On Besistance	_	_	33	45	0	V _{GS} = -10V, I _D = -5A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	40	55	mΩ	$V_{GS} = -4.5V, I_D = -4A$
Diode Forward Voltage	V_{SD}	_	-0.7	-1.0	V	V _{GS} = 0V, I _S = -1.0A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	1154	_		V _{DS} = -20V, V _{GS} = 0V f = 1.0MHz
Output Capacitance	Coss	_	84		pF	
Reverse Transfer Capacitance	Crss	_	66	_		
Gate Resistance	R_{G}		12.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)	Q_g		10.6	_		VDS = -20V, ID = -4.9A
Total Gate Charge (V _{GS} = -10V)	Q_g	_	21.5		nC	
Gate-Source Charge	Q_{gs}		2.2	_	IIC	
Gate-Drain Charge	Q_{gd}		3.3	_		
Turn-On Delay Time	t _{D(on)}	_	8.7	_		V _{DS} = -20V, I _D = -3.9A V _{GS} = -4.5V, R _G = 1Ω
Turn-On Rise Time	t _r	_	19.6	_	-0	
Turn-Off Delay Time	t _{D(off)}	_	34.9	_	nS	
Turn-Off Fall Time	t _f	_	25.5	_		
Body Diode Reverse Recovery Time	t _{rr}	_	9.61		nS	$I_S = -3.9A$, $dI/dt = 100A/\mu s$
Body Diode Reverse Recovery Charge	Q _{rr}		3.30	_	nC	$I_S = -3.9A$, $dI/dt = 100A/\mu s$

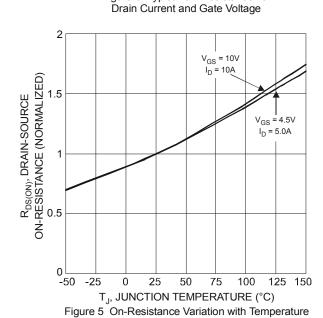
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 7. IAR and EAR rating are based on low frequency and duty cycles to keep TJ = +25°C
 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing.

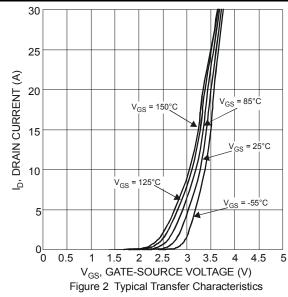


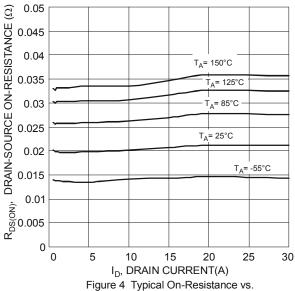
N-Channel Q2

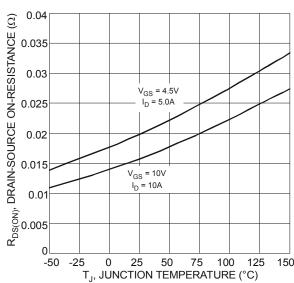












Drain Current and Temperature



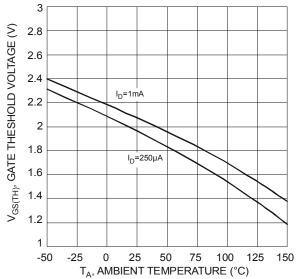
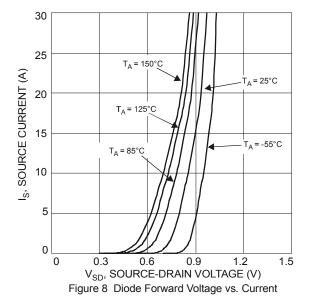
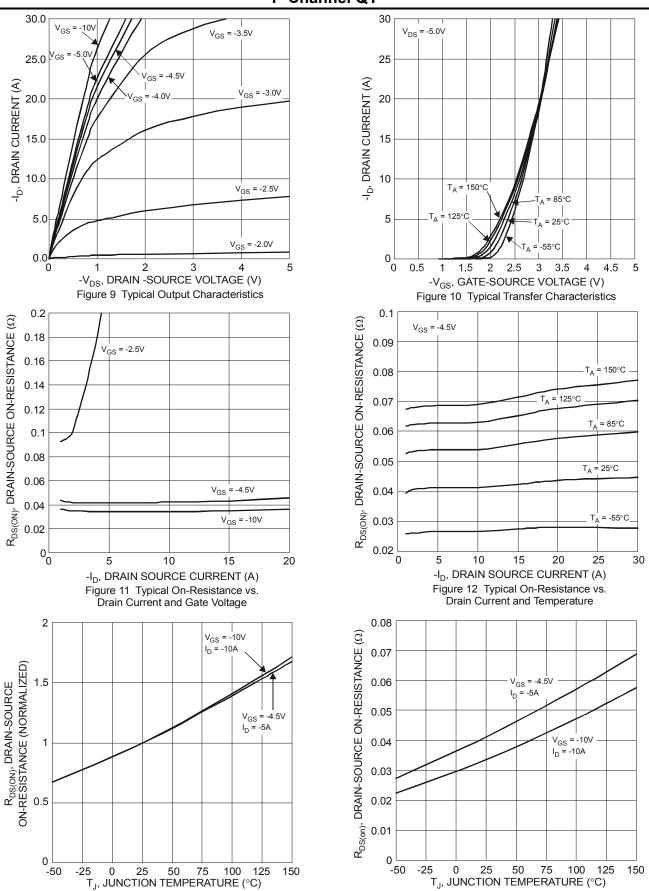


Figure 7 Gate Theshold Variation vs Ambient Temperature





P-Channel Q1



T_J, JUNCTION TEMPERATURE (°C)

Figure 13 On-Resistance Variation with Temperature

Figure 14 On-Resistance Variation with Temperature



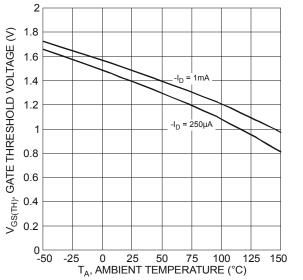
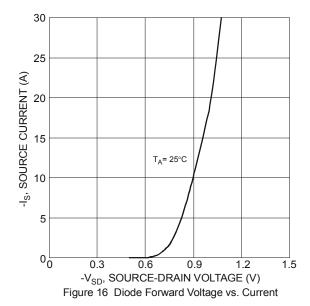
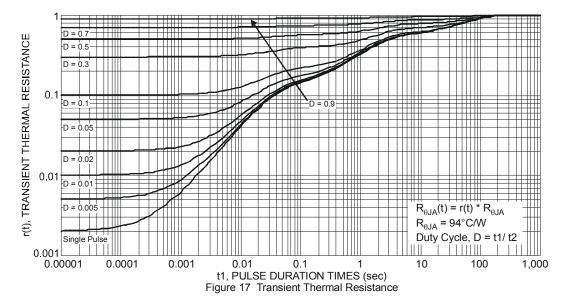


Figure 15 Gate Threshold Variation vs. Ambient Temperature

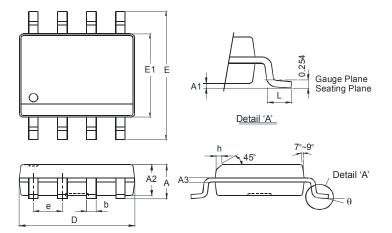






Package Outline Dimensions

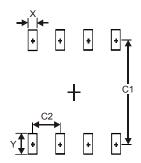
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8						
Dim	Min	Max				
Α	1	1.75				
A 1	0.10	0.20				
A2	1.30	1.50				
A3	0.15	0.25				
b	0.3	0.5				
D	4.85	4.95				
Е	5.90	6.10				
E1	3.85	3.95				
е	e 1.27 Typ					
h	-	0.35				
L	0.62	0.82				
θ	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
X	0.60			
Y	1.55			
C1	5.4			
C2	1.27			



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